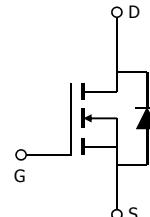
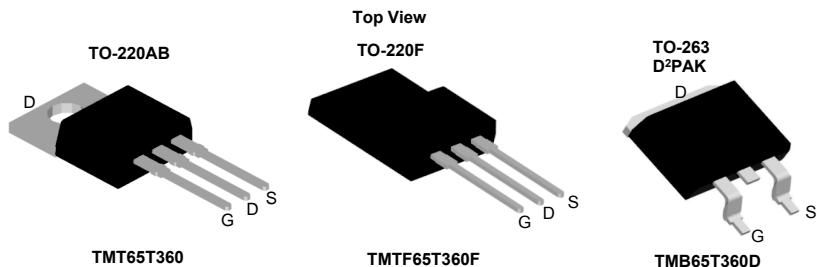


# TMT65T360 / TMTF65T360F / TMB65T360D N-CHANNEL SUPER JUNCTION POWER MOSFET

General Description	Product Summary						
<p>The series of devices use advanced trench gate super junction technology and design to provide excellent <math>R_{DS(ON)}</math> with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.</p>	<table style="width: 100%; border: none;"> <tr> <td style="width: 33%;"><math>V_{DS}</math></td><td style="width: 33%; text-align: center;">650V</td></tr> <tr> <td><math>I_D</math> (at <math>V_{GS}=10V</math>)</td><td style="text-align: center;">11.5A</td></tr> <tr> <td><math>R_{DS(ON)}</math> (at <math>V_{GS}=10V</math>)</td><td style="text-align: center;"><math>&lt; 360m\Omega</math></td></tr> </table> <p style="margin-top: 20px;">         100% UIS Tested          100% <math>R_g</math> Tested       </p> <div style="text-align: right; margin-top: 10px;">  </div>	$V_{DS}$	650V	$I_D$ (at $V_{GS}=10V$ )	11.5A	$R_{DS(ON)}$ (at $V_{GS}=10V$ )	$< 360m\Omega$
$V_{DS}$	650V						
$I_D$ (at $V_{GS}=10V$ )	11.5A						
$R_{DS(ON)}$ (at $V_{GS}=10V$ )	$< 360m\Omega$						


**Table 1. Absolute Maximum Ratings ( $T_c=25^\circ C$ )**

Parameter	Symbol	<b>TMT65T360 TMB65T360D</b>	<b>TMTF65T360F</b>	Unit
Drain-Source Voltage ( $V_{GS}=0V$ )	$V_{DS}$	650		V
Gate-Source Voltage ( $V_{DS}=0V$ ), AC( $f>1HZ$ )	$V_{GS}$	$\pm 30$		V
Continuous Drain Current at $T_c=25^\circ C$	$I_D(DC)$	11.5	11.5*	A
Continuous Drain Current at $T_c=100^\circ C$	$I_D(DC)$	7	7*	A
Pulsed drain current <b>(Note 1)</b>	$I_{DM}(\text{pulse})$	46	46*	A
Maximum Power Dissipation( $T_c=25^\circ C$ ) Derate above $25^\circ C$	$P_D$	101 0.81	32.6 0.26	W W/ $^\circ C$
Single pulse avalanche energy <b>(Note2)</b>	$E_{AS}$	144		mJ
Avalanche current <b>(Note 1)</b>	$I_{AR}$	6		A
Repetitive Avalanche energy , $t_{AR}$ limited by $T_{jmax}$ <b>(Note 1)</b>	$E_{AR}$	0.5		mJ

Parameter	Symbol	TMT65T360 TMB65T360D	TMTF65T360F	Unit
Drain Source voltage slope, $V_{DS} \leq 480$ V,	dv/dt	50		V/ns
Reverse diode dv/dt, $V_{DS} \leq 480$ V, $ I_{SD}  < I_D$	dv/dt	15		V/ns
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55...+150		°C

\* limited by maximum junction temperature

**Table 2. Thermal Characteristic**

Parameter	Symbol	TMT65T360 TMB65T360D	TMTF65T360F	Unit
Thermal Resistance, Junction-to-Case (Maximum)	$R_{thJC}$	1.24	3.83	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	$R_{thJA}$	62	80	°C /W

**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

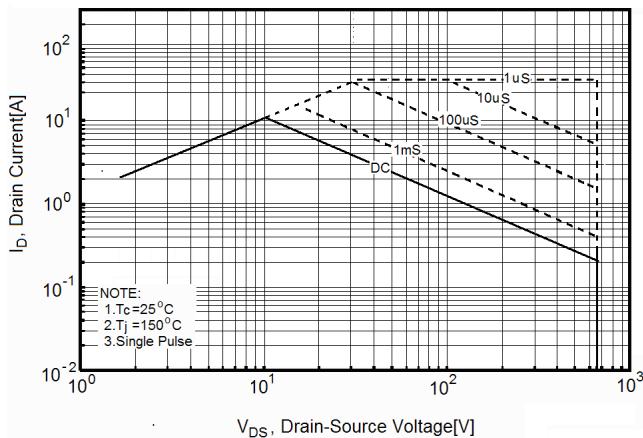
Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>On/off states</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0$ V $I_D=250\mu A$	650			V
Zero Gate Voltage Drain Current( $T_c=25^\circ C$ )	$I_{DSS}$	$V_{DS}=650$ V, $V_{GS}=0$ V		0.05	1	$\mu A$
Zero Gate Voltage Drain Current( $T_c=125^\circ C$ )	$I_{DSS}$	$V_{DS}=650$ V, $V_{GS}=0$ V			100	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20$ V, $V_{DS}=0$ V			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	3	3.5	4	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=10$ V, $I_D=7$ A		290	360	$m\Omega$
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=50$ V, $V_{GS}=0$ V, $f=1.0$ MHz		870		pF
Output Capacitance	$C_{oss}$			54		pF
Reverse Transfer Capacitance	$C_{rss}$			1.8		pF
Total Gate Charge	$Q_g$	$V_{DS}=480$ V, $I_D=11.5$ A, $V_{GS}=10$ V		19		nC
Gate-Source Charge	$Q_{gs}$			6		nC
Gate-Drain Charge	$Q_{gd}$			6.5		nC
<b>Switching times</b>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=380$ V, $I_D=5.5$ A, $R_G=3\Omega, V_{GS}=10$ V		11		nS
Turn-on Rise Time	$t_r$			8		nS
Turn-Off Delay Time	$t_{d(off)}$			58	70	nS
Turn-Off Fall Time	$t_f$			9	14	nS
<b>Source- Drain Diode Characteristics</b>						
Source-drain current(Body Diode)	$I_{SD}$	$T_c=25^\circ C$			11.5	A
Pulsed Source-drain current(Body Diode)	$I_{SDM}$				46	A
Forward on voltage	$V_{SD}$	$T_j=25^\circ C, I_{SD}=11.5$ A, $V_{GS}=0$ V		0.9	1.2	V
Reverse Recovery Time	$t_{rr}$	$T_j=25^\circ C, I_F=5.8$ A, $di/dt=100$ A/ $\mu s$		220		nS
Reverse Recovery Charge	$Q_{rr}$			2.2		uC
Peak Reverse Recovery Current	$I_{rrm}$			19		A

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

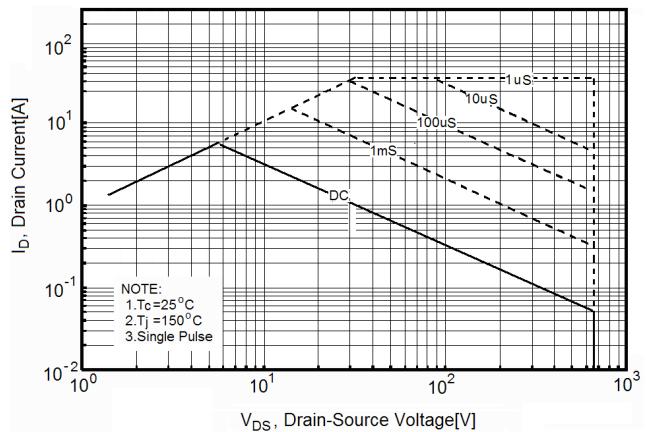
2.  $T_j=25^\circ C, V_{DD}=50$  V,  $V_{GS}=10$  V,  $R_G=25\Omega$

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

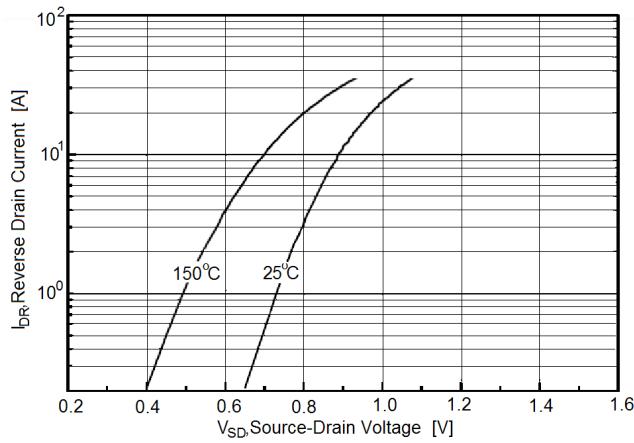
**Figure1. Safe operating area**



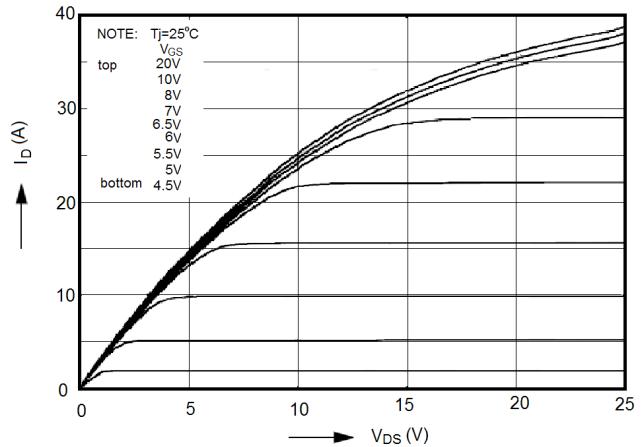
**Figure2. Safe operating area for TO-220F**



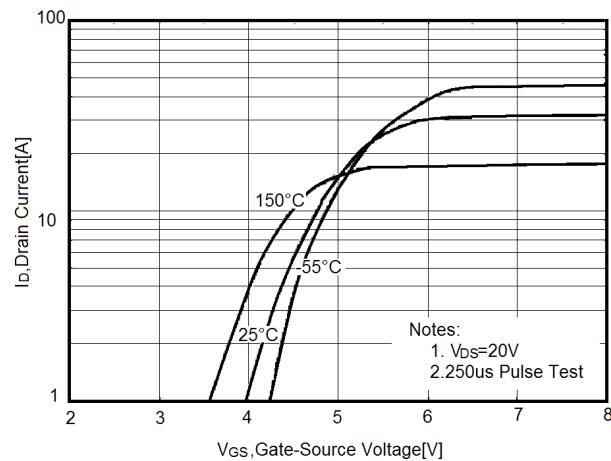
**Figure3. Source-Drain Diode Forward Voltage**



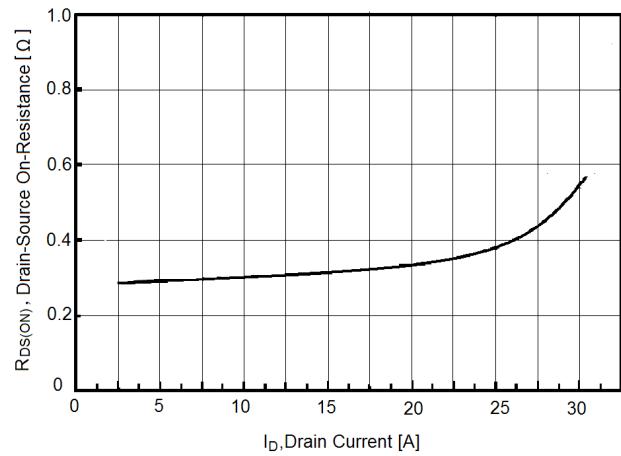
**Figure4. Output characteristics**



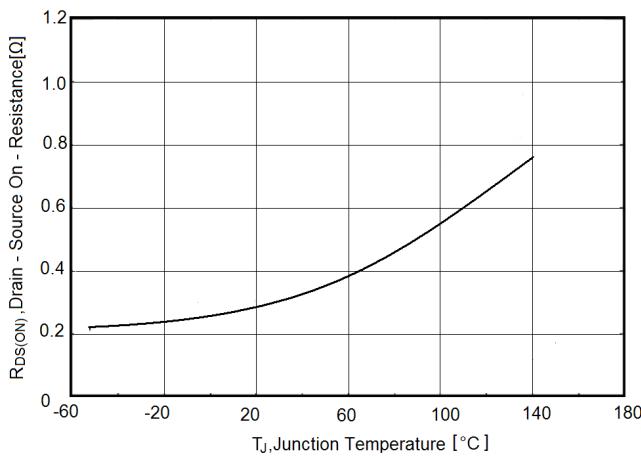
**Figure5. Transfer characteristics**



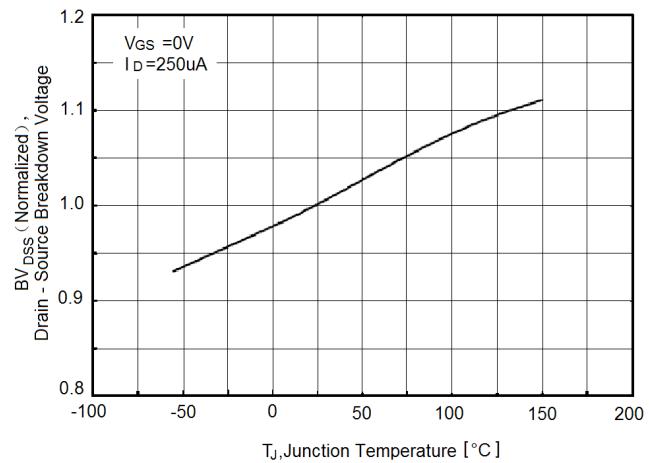
**Figure6. Static drain-source on resistance**



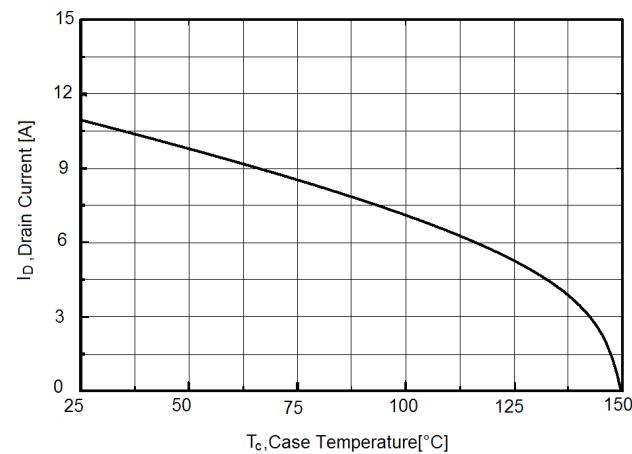
**Figure7.  $R_{DS(ON)}$  vs Junction Temperature**



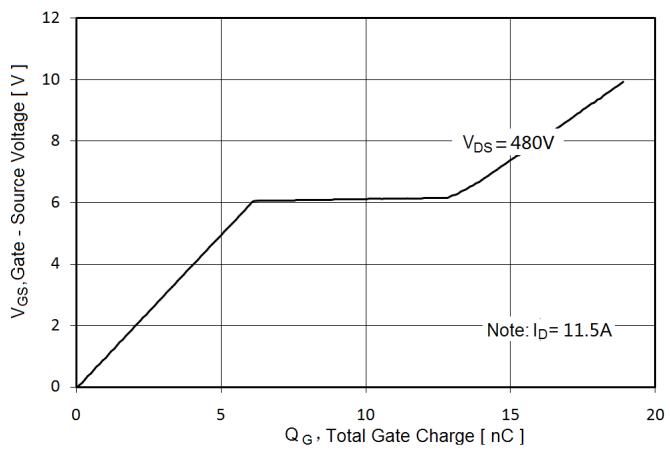
**Figure8.  $BV_{DSS}$  vs Junction Temperature**



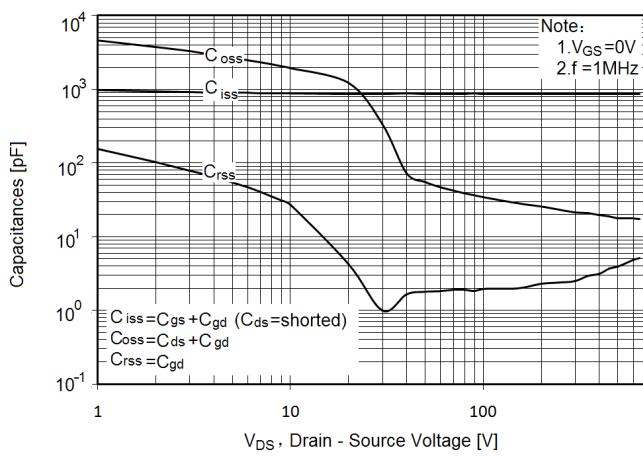
**Figure9. Maximum  $I_D$  vs Junction Temperature**



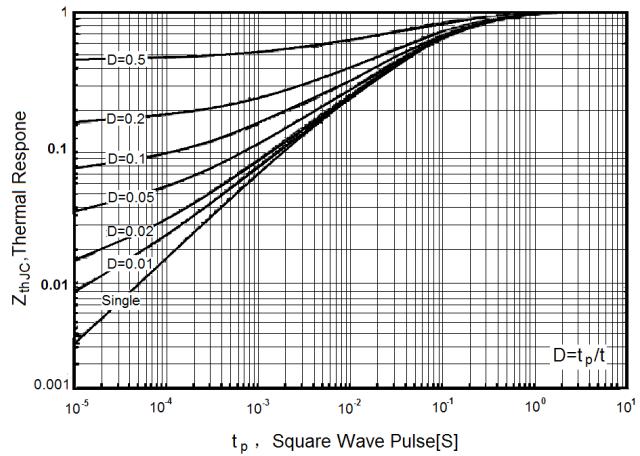
**Figure10. Gate charge waveforms**



**Figure11. Capacitance**

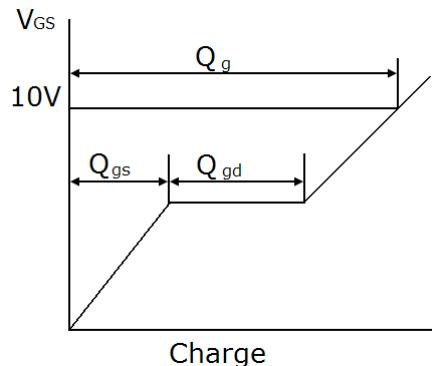
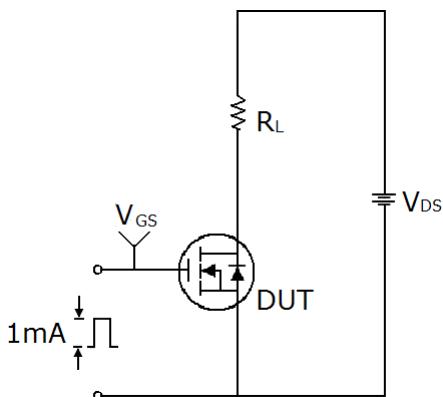


**Figure12. Transient Thermal Impedance**

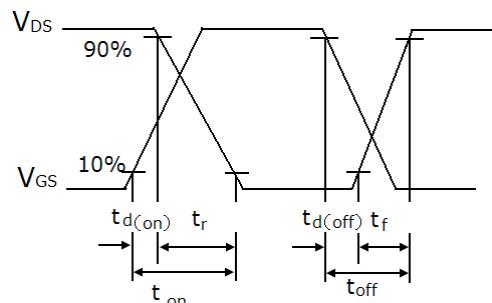
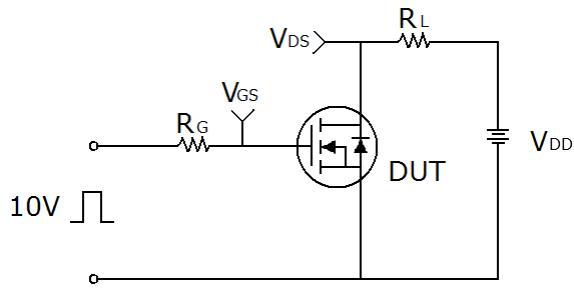


# Test circuit

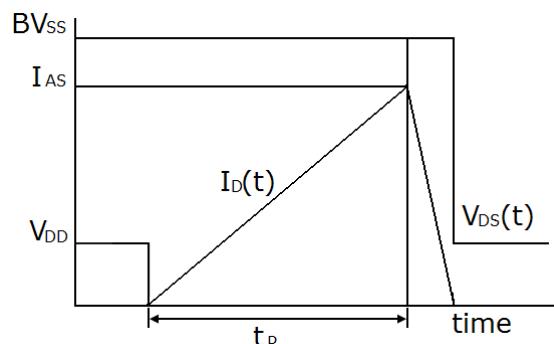
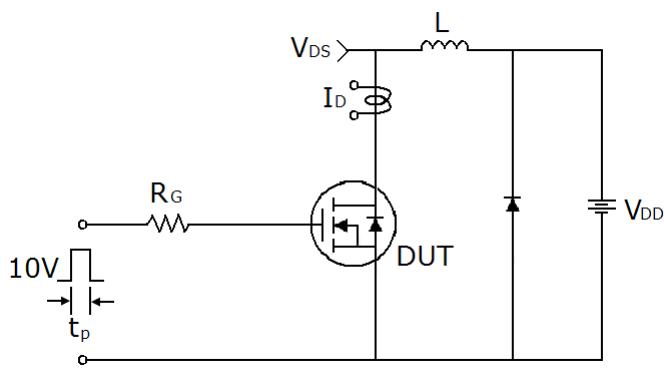
## 1) Gate charge test circuit & Waveform



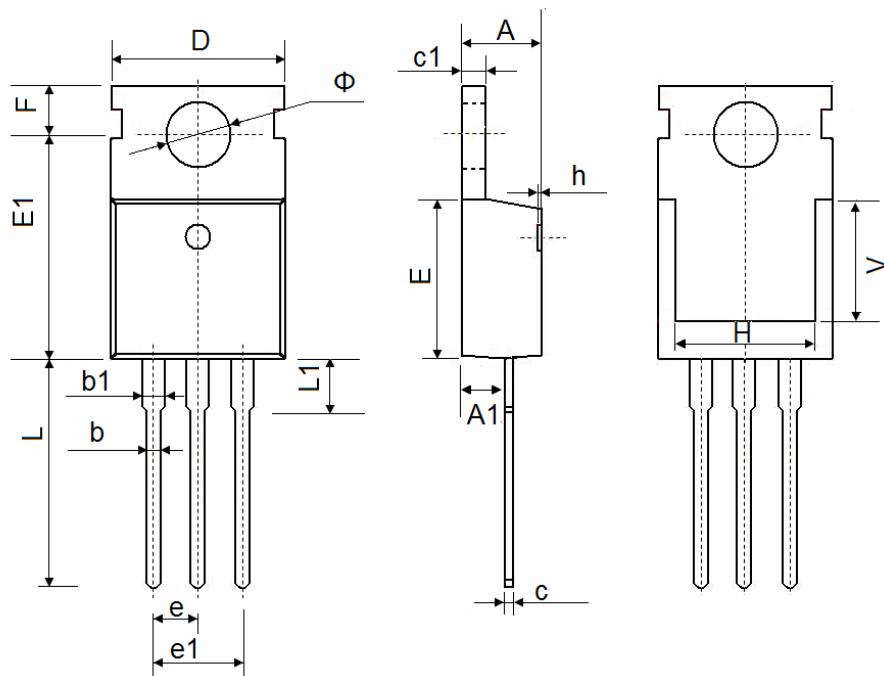
## 2) Switch Time Test Circuit:



## 3) Unclamped Inductive Switching Test Circuit & Waveforms

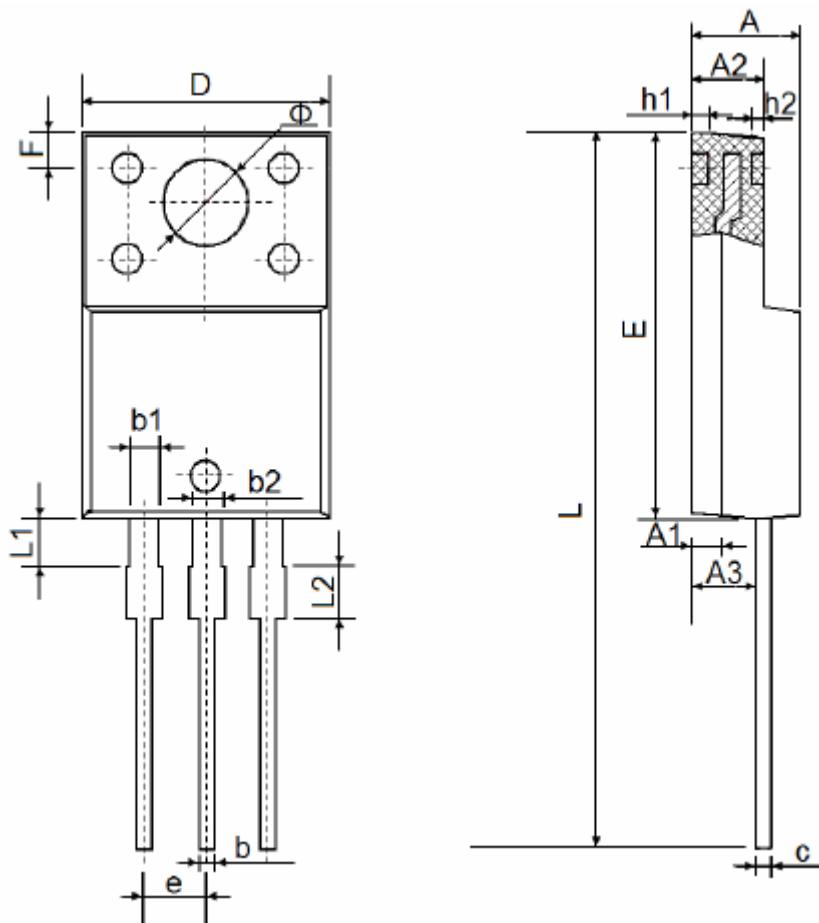


## TO-220AB Package Information



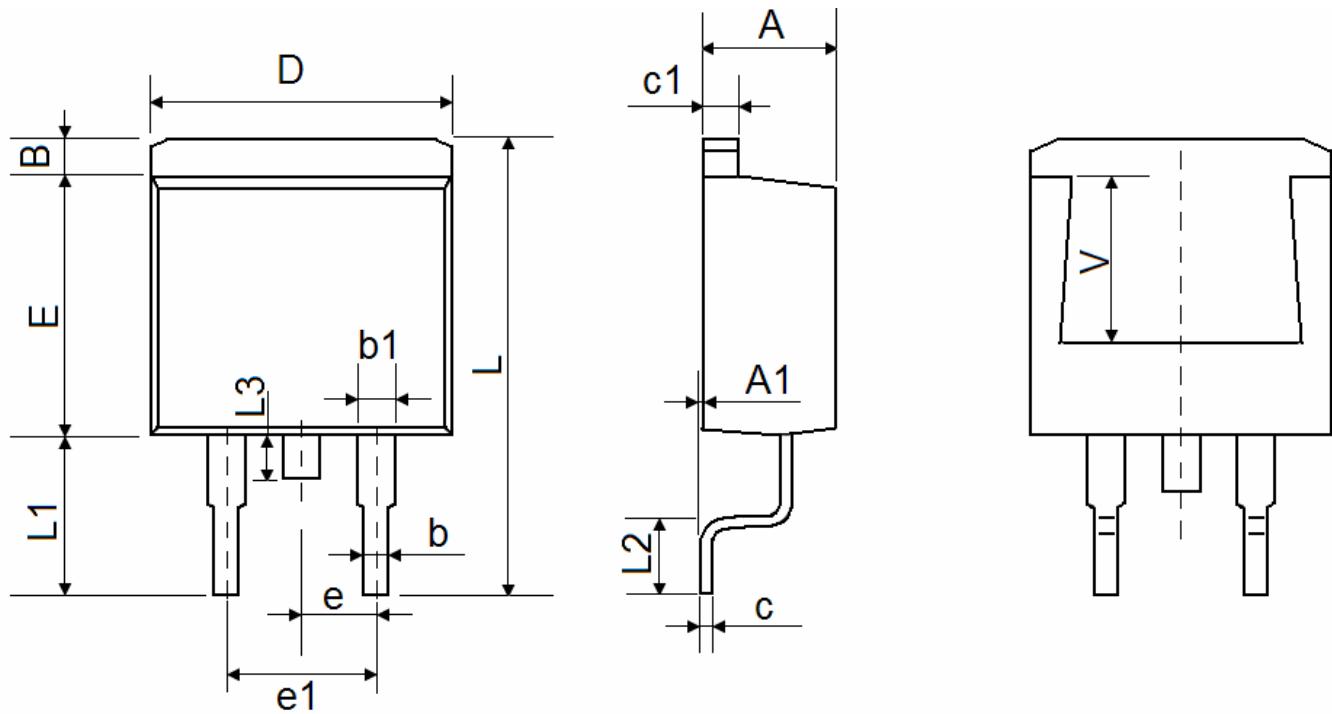
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181
A <sub>1</sub>	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b <sub>1</sub>	1.170	1.370	0.046	0.054
c	0.330	0.650	0.013	0.026
c <sub>1</sub>	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.9500	9.750	0.352	0.384
E <sub>1</sub>	12.650	12.950	0.498	0.510
e	2.540 TYP.		0.100 TYP.	
e <sub>1</sub>	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L <sub>1</sub>	2.850	3.250	0.112	0.128
V	7.500 REF.		0.295 REF.	
$\Phi$	3.400	3.800	0.134	0.150

## TO-220F Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	1.300REF		0.051REF	
A2	2.800	3.200	0.110	0.126
A3	2.500	2.900	0.098	0.114
b	0.500	0.750	0.020	0.030
b1	1.100	1.350	0.043	0.053
b2	1.500	1.750	0.059	0.069
c	0.500	0.750	0.020	0.030
D	9.960	10.360	0.392	0.408
E	14.800	15.200	0.583	0.598
e	2.540TYP.		0.100TYP	
F	2.700REF		0.106REF	
Φ	3.500REF		0.138REF	
h1	0.800REF		0.031REF	
h2	0.500REF		0.020REF	
L	28.000	28.400	1.102	1.118
L1	1.700	1.900	0.067	0.075
L2	1.900	2.100	0.075	0.083

## TO-263 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184
A1	0.000	0.150	0.000	0.006
B	1.170	1.370	0.046	0.054
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
L	15.050	15.450	0.593	0.608
L1	5.080	5.480	0.200	0.216
L2	2.340	2.740	0.092	0.108
L3	1.300	1.700	0.051	0.067
V	5.600 REF		0.220 REF	